



3D 锡膏测厚仪

3D SOLDER PASTE INSPECTOR



超强分析
Super analysis



精巧平台
Exquisite platform



激光焊接机身
Laser welding



真实 3D
Realistic 3D

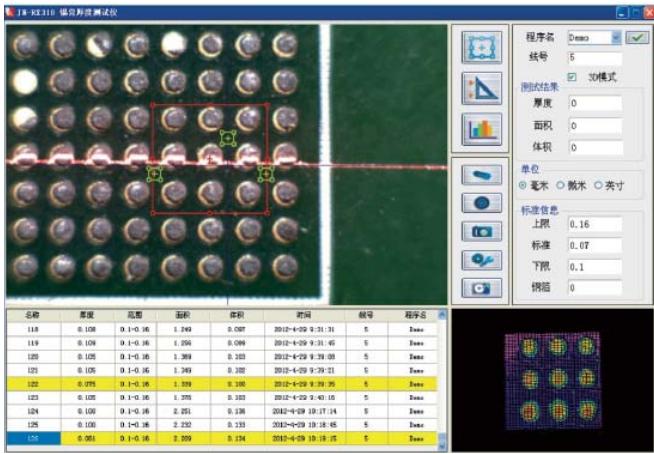


RX310

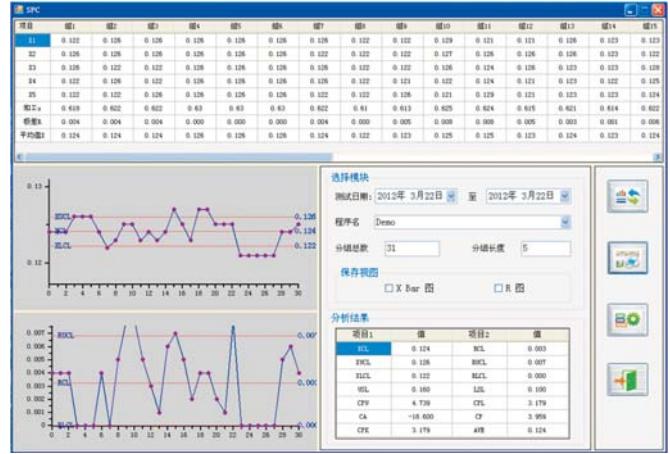
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软件界面/Software interface



SPC 界面/SPC interface



特点/Feature

- 采用原装德国进口高清彩色相机，保证测试的高精度和高稳定性。
- 采用军用级别的二级激光，降低外界环境光源的干扰，更加稳定，使用寿命更长。
- 采用灵活的硬件设计，可调光源、激光和相机，可对不同颜色的PCB板进行测试。
- 4D测量模式获取最真实的锡膏厚度，3D数据模型重组方便分析。
- 软件分析条件基于数据库，根据分析条件实现预警功能，直观易懂。
- 强大的报表分析功能，自动生成R-Chart, X-Bar,自动计算CPK。
- 导出详细的SPC报表，完全避免手写报表的各种弊端。
- 软件采用简单实用的理念，侧重于测试的高精度设计，校正块重复精度达到正负0.001mm。

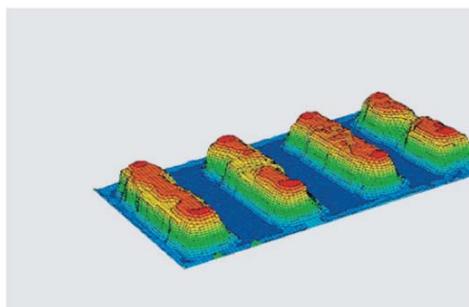
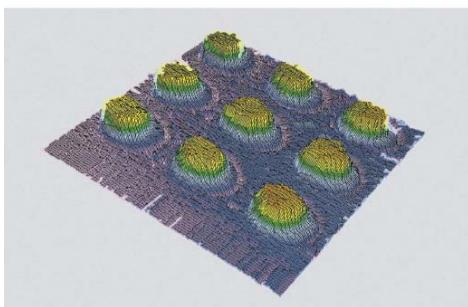
- Original German sharp color camera to guarantee the high accuracy and high stability of the test.
- With military grade secondary laser to reduce the interference of external environment light sources, more stable and longer service life.
- A flexible hardware design, adjustable light laser and camera, can test different colors of PCB .
- 4D measurement mode to obtain the real solder paste thickness, the 3D data model restructuring is more convenient to analysis.
- Software analysis conditions based on the database , according to the analysis conditions to realize the early pre function, intuitive and easy to understand.
- Powerful reports analysis, automatically generate R- Chart and X-Bar, automatically calculate CPK.
- Export the complete and detail SPC report , completely avoid all sorts of disadvantages of written reports.
- Software with simple and practical idea, focus on the test of high precision design, the repetitive accuracy of standard block reaches plus or minus 0.001 mm.

技术参数/Technical parameters

- 最高测量精度 : 0.001mm
- 重复精度 : $\pm 0.003\text{mm}$
- 镜头放大倍率 : 3X
- 光学检测系统 : 彩色130万像素CCD
- 激光镭射系统 : 红光激光模组
- 平台系统 : 半自动
- 测量原理 : 非接触式激光束
- 最大测量高度 : 1mm
- SPC软件/SPC : Cpk.cp.xbar R&S
- 计算机系统 : MS-Win7 Pro
- 软件语言版本 : 简/繁体中文、英文
- 电源 : 单相AC 220V, 60/50HZ
- 重量 : 25kg

- Tiptop measure precision 0.001mm
- Repetitive accuracy $\pm 0.003\text{mm}$
- Lens magnification 3X
- Optics inspection system : 1.3 million pixel color CCD
- Lase system: Laser module with glowing
- Platform system : Semi-automatic
- Measuring principle: Non-touch laser beam
- Max measure height 1mm
- SPC software/ SPCJcpk . Cp.Xbar R&S
- computer system JMS-Win7Pro
- Software language: Simplified Chinese, traditional Chinese, English
- Power Source : Single-phase AC220V, 60/50HZ
- Weight: 25kg
- Product shape size: 460(W)x500(D)x350(H) MM

3D 效果图/Renderings



CPK 报表/CPK report

